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1. Name of conveying party(ies): Naoki FUKUTOMI, Yoshiaki WAKASHIMA, Susumu NAOYUKI, and Akinari KIDA Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No 3. Nature of conveyance: ☒Assignment ☐ Merger	2. Name and address of receiving party(ies): Name: Hitachi Chemical Co., Ltd Address: 1-1, Nishishinjuku 2-chome, Shinjuku-ku, Tokyo 163-0449 JAPAN	
□Security Agreement □Change of Name		
□Other	Country (if other than USA): JAPAN	
Execution Date: September 13, 16, 21 and 17, 1999		
4. Application number(s) or patent number(s):		
If this document is being filed together with a new application, the executio	n date of the application is: September 13, 16, 21 and 17, 1999	
A. Patent Application No. (s) filed herewith	B. Patent No.(s)	
Additional numbers attached? ☐ Yes ☒ No ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐ ☐		
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PENNIE & EDMONDS LLP 1155 Avenue of the Americas New York, NY 10036	7. Total fee (37 CFR 3.41):	
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Name of conveying party(ies):	2. Name and address of receiving party(ies):	
, ,	Name: Hitachi Chemical Co., Ltd	
Naoki FUKUTOMI, Yoshiaki WAKASHIMA,		
Susumu NAOYUKI, and Akinari KIDA		
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No	Address: 1-1, Nishishinjuku 2-chome,	
	Shinjuku-ku,	
3. Nature of conveyance:	Tokyo_163-0449 JAPAN	
⊠Assignment □Merger	TORYO 103-0445 OREAN	
□Security Agreement □Change of Name		
□Other	Country (if other than USA): JAPAN	
Execution Date: <u>September 13, 16, 21 and 17, 1999</u>		
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Charles E. Miller 24,576	October 29, 1999	
Name of Person Signing Reg. No. Signature	Date	
Total nun	nber of pages including cover sheet: 3	

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PATENT REEL: 010458 FRAME: 0561

1,2**2.**00, 100 4,000 (2)

ASSIGNMENT

WHEREAS, WE, <u>Naoki Fukutomi, Yoshiaki</u> Akinari Kida	Wakashima, Susumu Naoyuki,	
ASSIGNORS, citizens of Japan, residing at 8463-5, Yuki, Yu	ki-shi Tharaki-ken 307-0001	
Japan; 1-3-1, Hosoyama, Asao-ku, Kawasaki-shi,		
7188-32, Yuki, Yuki-shi, Ibaraki-ken 307-0001		
Nogicho, Shimotsuga-qun, Tochigi-ken 329-0101		
	-	
are the inventors of the invention in SUBSTRATE FOR MOUNTING SEMICONDUCTOR CHIP, METHOD OF FABRICATING THE SUBSTRATE AND SEMICONDUCTOR		
DEVICE		
for which we have executed an application for a Patent of the United St	ates	
on even date herewith and/or which is identified by Pennie & Edr. which was filed on <u>April 30</u> , 1998, as PCT Internation		
and WHEREAS, Hitachi Chemical Company, Ltd	d,	
whose address is 1-1, Nishishinjuku 2-chome, Shinj ASSIGNEE, is desirous of obtaining the entire right, title and interest application:	<u>uku-ku, Tokyo 163-0449, Japan</u> ,	
NOW, THEREFORE, in consideration of the sum of One Do valuable consideration, the receipt of which is hereby acknowledged, we by these presents do hereby sell, assign, transfer and set over, representatives and assigns, the entire right, little and interest in, to a States application and all divisions, renewals and continuations thereof granted thereon and all reissues and extensions thereof; and all applications the limitation, all applications for patents, utility models, and design any country or countries foreign to the United States, together with claim for the same the property rights under the Patent Laws of the United international agreement such application is filed, as may be applicable; and all forms of limitation, patents, utility models, inventors' certificates and designs country or countries foreign to the United States and all extensions, ren	re have sold, assigned, transferred and set over, and unto the said ASSIGNEE, its successors, legal and under the said invention, and the said United and all Patents of the United States which may be ations for industrial property protection, including, gas which may hereafter be filed for said invention the right to file such applications and the right to United States, the International Convention for the cor the domestic laws of the country in which any industrial property protection, including, without which may be granted for said invention in any	
AND WE HEREBY authorize and request the Commissioner issue any and all patents and other evidence or forms of industrial propation assignments and assigns, in accessors, legal representatives and assigns, in accessors.	perty protection on applications as aforesaid, to the	
AND WE HEREBY covenant and agree that we have full rig that we have not executed, and will not execute, any agreement in confl		
AND WE HEREBY further covenant and agree that we will legal representatives and assigns, any facts known to us respecting sai all lawful papers, execute all divisional, continuing, reissue and foreig do everything possible to aid the said ASSIGNEE, its successors, lega proper protection for said invention.	d invention, and testify in any legal proceeding, sign napplications, make all rightful oaths, and generally	
IN TESTIMONY WHEREOF, we hereunto set our hands a signatures.	and seals the day and year set below our respective	
Nacki Fukutonii L.S. [Name] Nacki FUKUTOMI	Signed and sworn to before me this day of, 199	
September 13, 1999 [Date]	[Notary Public or U.S. Diplomatic or Consular Official] [continued on page 2]	

PATENT REEL: 010458 FRAME: 0562

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JOINT

[Name] Yoshiaki WAKASHIMA	L.S.	Signed and sworn to before me this, 199
Jacknehw Wakashmas [Date]		
		[Notary Public or U.S. Diplomatic or Consular Official]
September 16, 1999		
	L.S.	Signed and sworn to before me
[Name] Susumu NAOYUKI		this day of, 199
Susumu Naoyuk!		
[Date]//		[Notary Public or U.S. Diplomatic or Consular Official]
September 21, 1999		
	L.S.	Signed and sworn to before me
[Name] Akinari KIDA		this, 199
Akinari Kida		
[Date]		[Notary Public or U.S. Diplomatic or Consular Official]
September 17, 1999		